

R07DS0762EJ0101

Rev.1.01

May 28, 2013

μ**PA2812T1L**

P-channel MOSFEF

–30 V, –30 A, 4.8 mΩ

Description

The μ PA2812T1L is P-channel MOS Field Effect Transistor designed for DC/DC converter and power management applications of portable equipment.

Features

- $V_{DSS} = -30 \text{ V} (T_A = 25^{\circ}\text{C})$
- Low on-state resistance
 - ---- $R_{DS(on)} = 4.8 \text{ m}\Omega \text{ MAX}. (V_{GS} = -10 \text{ V}, I_D = -30 \text{ A})$
- 4.5 V Gate-drive available
- Small & thin type surface mount package with heat spreader
- Pb-free and Halogen free



Ordering Information

Part No.	Lead Plating	Packing	Package
μPA2812T1L-E2-AT ^{*1}	Pure Sn	Tape 3000 p/reel	8-pin HVSON (3333)
μι Α201211E-E2-Α1		Tape 5000 p/Teel	typ. 0.028 g

Note: *1. Pb-free (This product does not contain Pb in external electrode and other parts.)

Absolute Maximum Ratings (T_A = 25°C)

Item	Symbol	Ratings	Unit
Drain to Source Voltage ($V_{GS} = 0 V$)	V _{DSS}	-30	V
Gate to Source Voltage (V _{DS} = 0 V)	V _{GSS}	∓20	V
Drain Current (DC) ($T_c = 25^{\circ}C$)	I _{D(DC)}	∓30	A
Drain Current (pulse) *1	I _{D(pulse)}	∓120	A
Total Power Dissipation *2	P _{T1}	1.5	W
Total Power Dissipation (PW = 10 sec) *2	P _{T2}	3.8	W
Total Power Dissipation ($T_c = 25^{\circ}C$)	P _{T3}	52	W
Channel Temperature	T _{ch}	150	۵°
Storage Temperature	T _{stg}	-55 to +150	۵°
Single Avalanche Current *3	I _{AS}	25	A
Single Avalanche Energy *3	E _{AS}	62	mJ

Thermal Resistance

Channel to Ambient Thermal Resistance *2	R _{th(ch-A)}	83.3	°C/W
Channel to Case (Drain) Thermal Resistance	R _{th(ch-C)}	2.4	°C/W

Notes: *1. PW \leq 10 μ s, Duty Cycle \leq 1%

- *2. Mounted on a glass epoxy board of 25.4 mm x 25.4 mm x 0.8 mmt
- *3. Starting T_{ch} = 25°C, V_{DD} = -15 V, R_G = 25 Ω , V_{GS} = -20 \rightarrow 0 V, L = 100 μ H

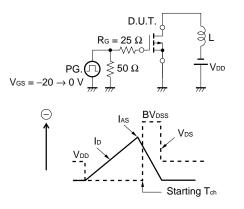


Electrical Characteristics (T_A = 25°C)

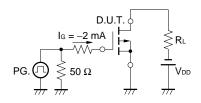
Item	Symbol	MIN.	TYP.	MAX.	Unit	Test Conditions
Zero Gate Voltage Drain Current	I _{DSS}			-1	μA	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$
Gate Leakage Current	I _{GSS}			∓100	nA	$V_{GS} = \mp 20 \text{ V}, V_{DS} = 0 \text{ V}$
Gate Cut-off Voltage	V _{GS(off)}	-1.0		-2.5	V	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ mA}$
Forward Transfer Admittance *1	y _{fs}	8.0			S	$V_{DS} = -10 \text{ V}, I_D = -15 \text{ A}$
Drain to Source On-state	R _{DS(on)1}		3.8	4.8	mΩ	$V_{GS} = -10 \text{ V}, I_D = -30 \text{ A}$
Resistance *1	R _{DS(on)2}		6.4	9.9	mΩ	$V_{GS} = -4.5 \text{ V}, I_D = -15 \text{ A}$
Input Capacitance	C _{iss}		3740		pF	$V_{DS} = -10 V,$
Output Capacitance	C _{oss}		1775		pF	$V_{GS} = 0 V,$
Reverse Transfer Capacitance	C _{rss}		1500		pF	f = 1 MHz
Turn-on Delay Time	t _{d(on)}		24		ns	$V_{DD} = -15 \text{ V}, I_D = -15 \text{ A},$
Rise Time	t _r		53		ns	$V_{GS} = -10 V$,
Turn-off Delay Time	t _{d(off)}		176		ns	R _G = 10 Ω
Fall Time	t _f		252		ns	-
Total Gate Charge	Q _G		100		nC	$V_{DD} = -24 V,$
Gate to Source Charge	Q _{GS}		11		nC	$V_{GS} = -10 V$,
Gate to Drain Charge	Q _{GD}		48		nC	I _D = -30 A
Body Diode Forward Voltage *1	V _{F(S-D)}		0.85		V	$I_F = 30 \text{ A}, V_{GS} = 0 \text{ V}$
Reverse Recovery Time	t _{rr}		196		ns	$I_F = 30 \text{ A}, V_{GS} = 0 \text{ V},$
Reverse Recovery Charge	Q _{rr}		297		nC	di/dt = 100 A/ <i>µ</i> s

Note: *1. Pulsed

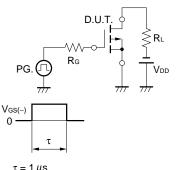
TEST CIRCUIT 1 AVALANCHE CAPABILITY



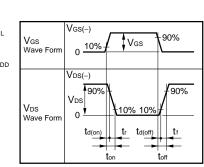
TEST CIRCUIT 3 GATE CHARGE



TEST CIRCUIT 2 SWITCHING TIME







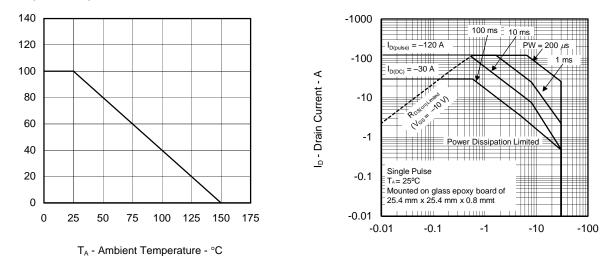


dT - Percentage of Rated Power - %

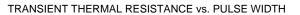
Typical Characteristics ($T_A = 25^{\circ}C$)

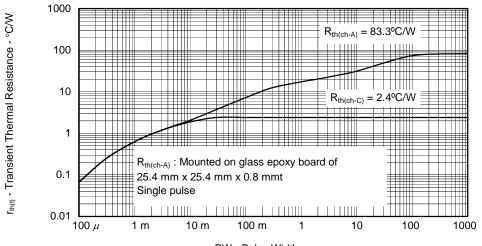
DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA

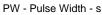
FORWARD BIAS SAFE OPERATING AREA



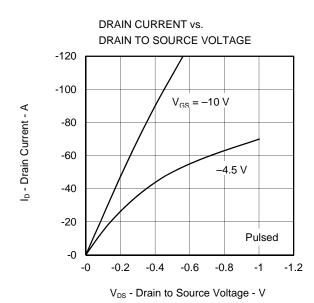
 V_{DS} - Drain to Source Voltage - V



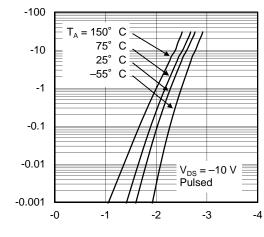




I_D - Drain Current - A

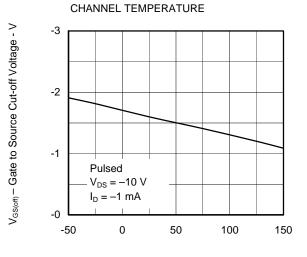






V_{GS} - Gate to Source Voltage - V

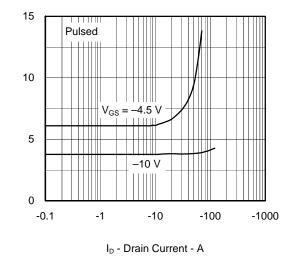
 $R_{\text{DS(on)}}$ - Drain to Source On-state Resistance - $m\Omega$



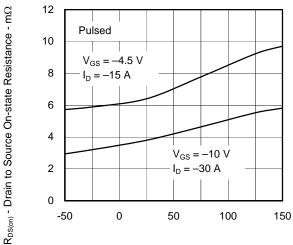
GATE TO SOURCE CUT-OFF VOLTAGE vs.

T_{ch} - Channel Temperature - °C

DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

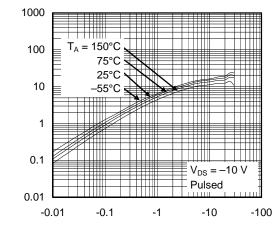






T_{ch} - Channel Temperature - °C

FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

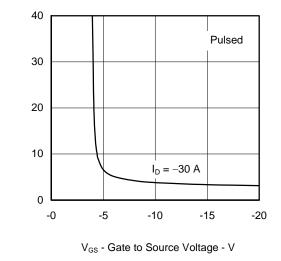


 $\mid y_{fs} \mid$ - Forward Transfer Admittance - S

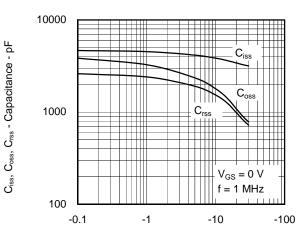
 $R_{\text{DS(on)}}$ - Drain to Source On-state Resistance - $m\Omega$

I_D - Drain Current - A

DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



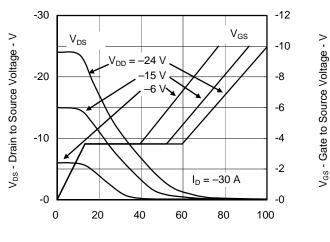
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



V_{DS} - Drain to Source Voltage - V

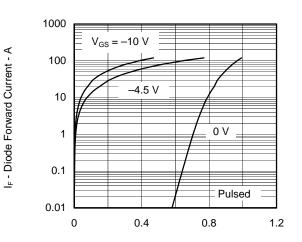


DYNAMIC INPUT/OUTPUT CHARACTERISTICS



Q_G - Gate Charge - nC

SOURCE TO DRAIN DIODE FORWARD VOLTAGE

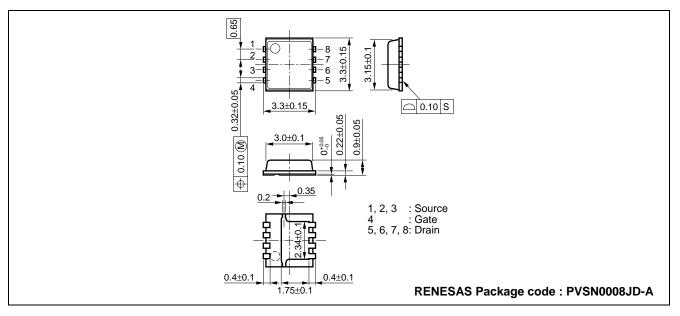


 $V_{\text{F(S-D)}}$ - Source to Drain Voltage - V

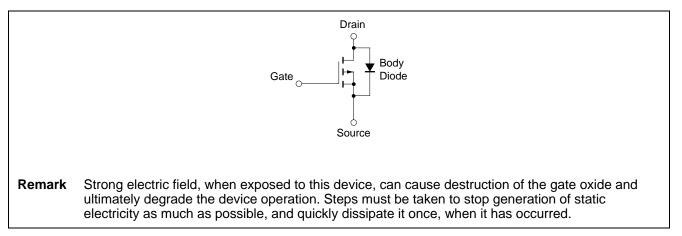


Package Drawings (Unit: mm)

8-pin HVSON (3333)



Equivalent Circuit





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